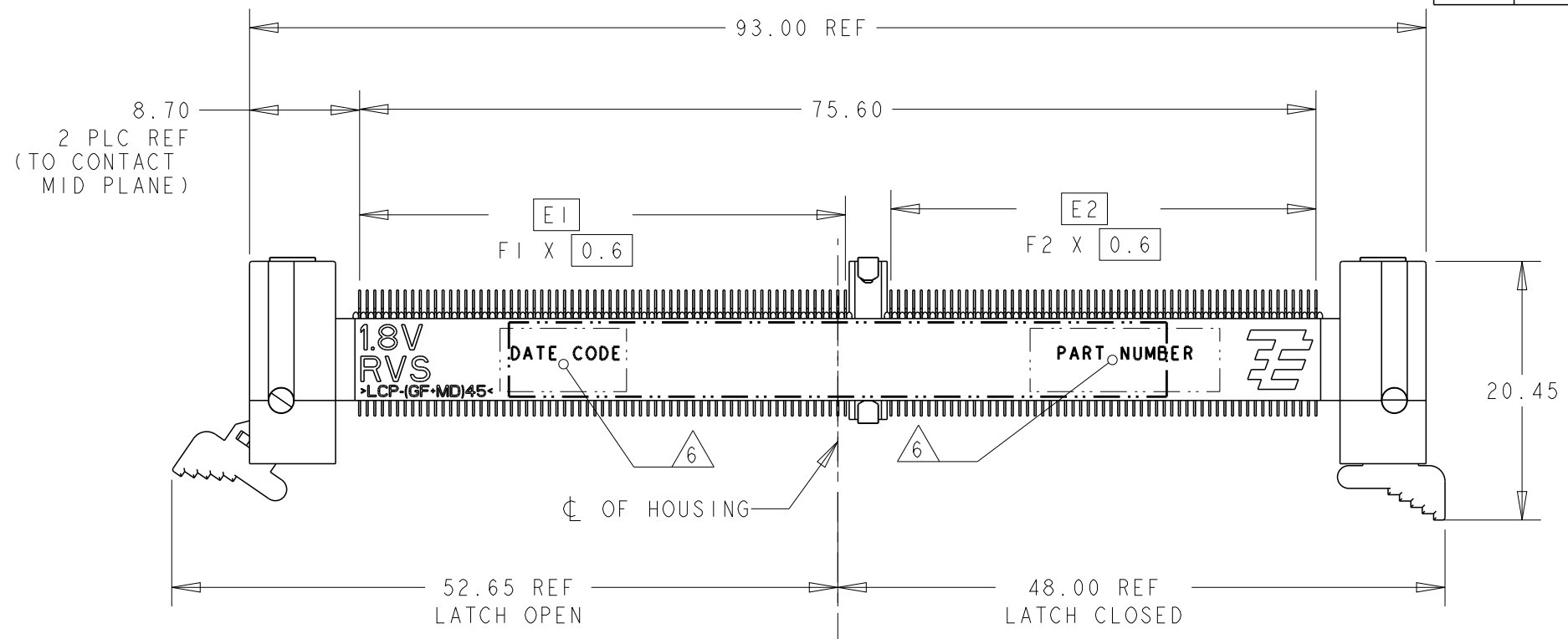


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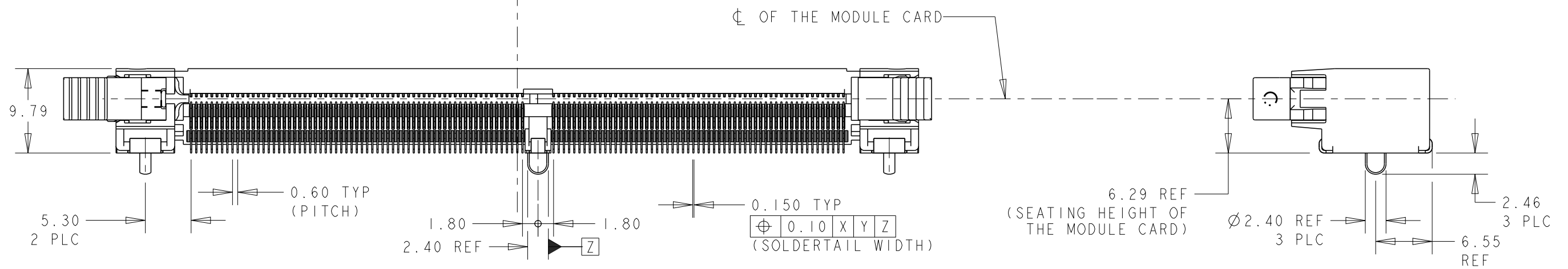
LOC
DY

DIST
-

REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
	B5	REVISED PER ECR-11-022142	01NOV2011	SYJ	LSF



- 1 MATERIAL: HOUSING: HIGH TEMP LCP, BLACK, UL94V-0
LATCHES: HIGH TEMP LCP, NATURAL, UL94V-0
CONTACTS: COPPER ALLOY
SOLDERPEGS: COPPER ALLOY
- 2 FINISH: ENGAGEMENT AREAS: 0.76µm MIN GOLD OVER
1.25µm MIN NICKEL
SOLDERTAILS: 0.02µm MIN GOLD OVER
1.25µm MIN NICKEL
- 3 FINISH: ENGAGEMENT AREAS: 0.38µm MIN GOLD OVER
1.25µm MIN NICKEL
SOLDERTAILS: 0.02µm MIN GOLD OVER
1.25µm MIN NICKEL
- 4 ACCEPTS 1.0mm THICK MEMORY MODULE, PER JEDEC MO-244,
WITH BEVELS (FOR INSERTION LEAD-IN) REQUIRED.
- 5 PRODUCT SHALL BE PACKED IN JEDEC HARD TRAY (BLACK).
- 6 PART NUMBER AND DATE CODE SHALL BE MARKED LEGIBLY
AS SHOWN. DATE CODE FORMAT: YYWWD.



64	56	38.4	33.6	45.5	40.7	DDR3 (AB/BB/CB) ; STD	1.5V	3	I- -4
64	56	38.4	33.6	45.5	40.7	DDR2 (AA/BA/CA) ; STD	1.8V	3	I- -3
56	64	33.6	38.4	40.7	45.5	DDR3 (AB/BB/CB) ; RVS	1.5V	3	I- -2
56	64	33.6	38.4	40.7	45.5	DDR2 (AA/BA/CA) ; RVS	1.8V	3	I- -1
64	56	38.4	33.6	45.5	40.7	DDR3 (AB/BB/CB) ; STD	1.5V	2	-4
64	56	38.4	33.6	45.5	40.7	DDR2 (AA/BA/CA) ; STD	1.8V	2	-3
56	64	33.6	38.4	40.7	45.5	DDR3 (AB/BB/CB) ; RVS	1.5V	2	-2
56	64	33.6	38.4	40.7	45.5	DDR2 (AA/BA/CA) ; RVS	1.8V	2	-1
F2	F1	E2	E1	B2	B1	VARIATION ; ORIENTATION MODULE	VOLTAGE MARKING	CONTACT FINISH	P/N

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DWN WYLEE 18MAY2007
 CHK YJ SEE
 APVD SF LEONG
 PRODUCT SPEC 108-51091
 APPLICATION SPEC 114-51011
 WEIGHT -

STE TE CONNECTIVITY
Singapore

NAME ASSEMBLY, MINIDIMM, R/A, LF
0.60mm PITCH, 244 CKTS,
DDR2/3

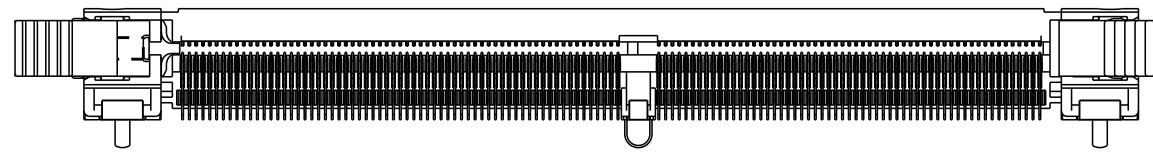
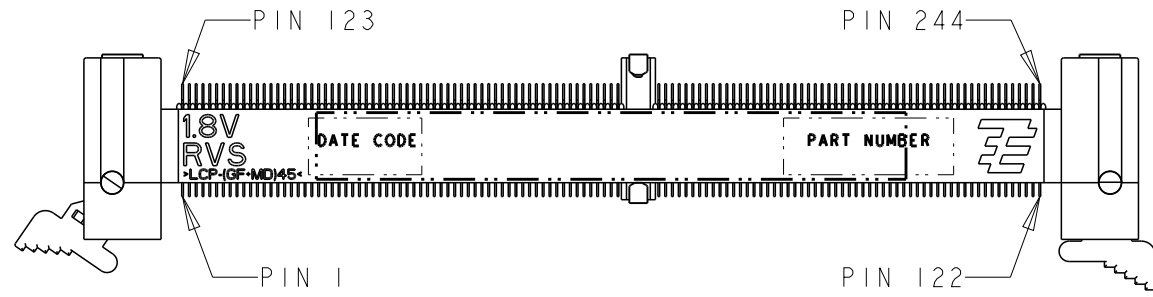
SIZE A3 CAGE CODE 00779 DRAWING NO C-1735438

CUSTOMER DRAWING SCALE 1:1 SHEET 1 OF 5 REV B5

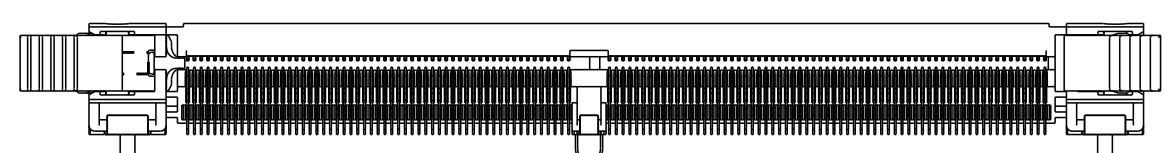
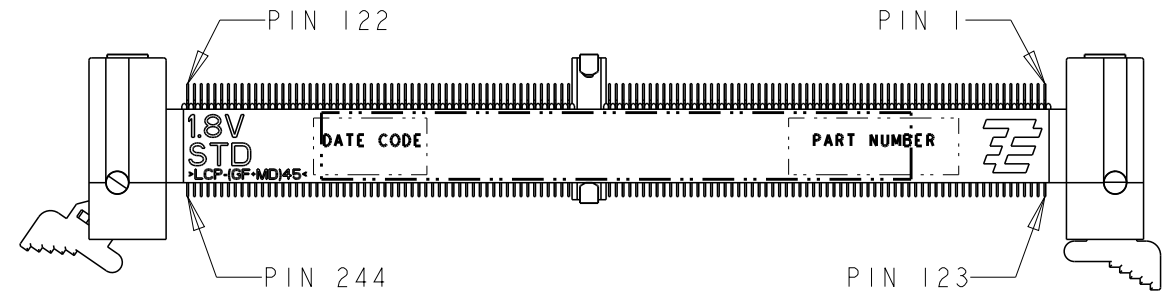
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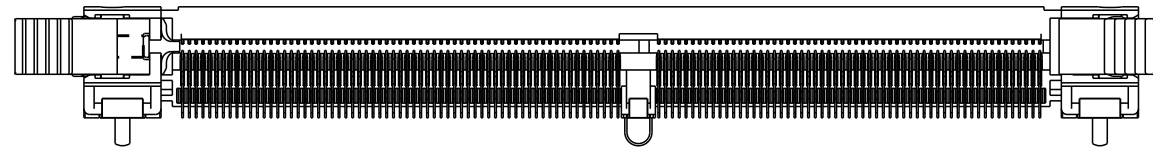
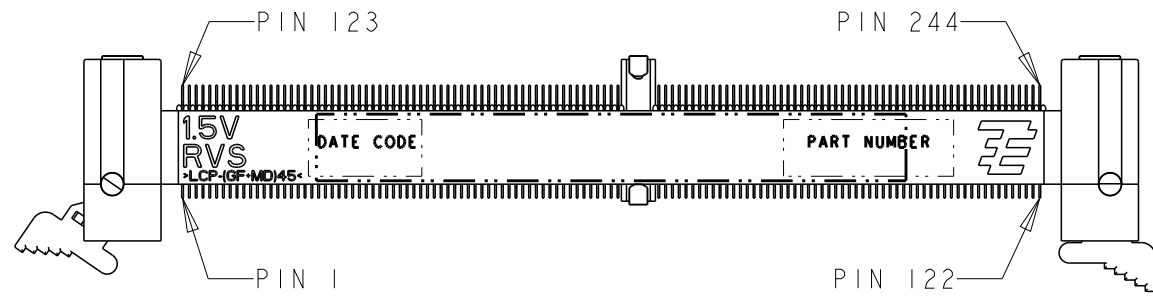
LOC	DIST	REVISIONS					
DY	-	P	LTR	DESCRIPTION	DATE	DWN	APVD
		-		SEE SHEET 1	-	-	-



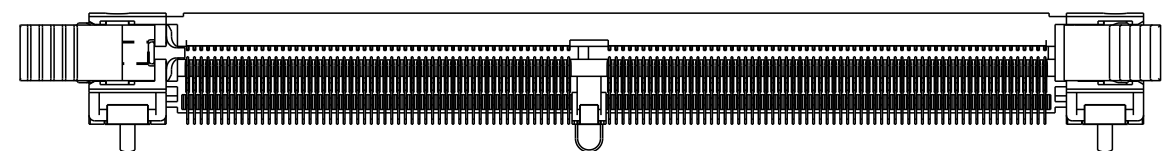
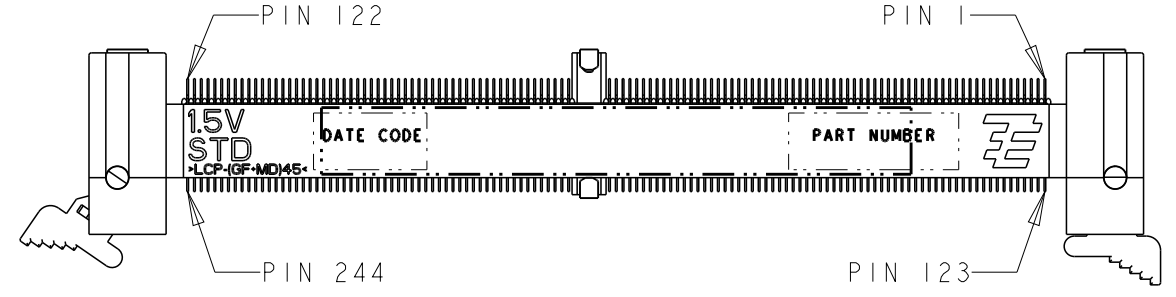
P/N X- -1
(1.8V RVS)
SCALE 3:2



P/N X- -3
(1.8V STD)
SCALE 3:2



P/N X- -2
(1.5V RVS)
SCALE 3:2

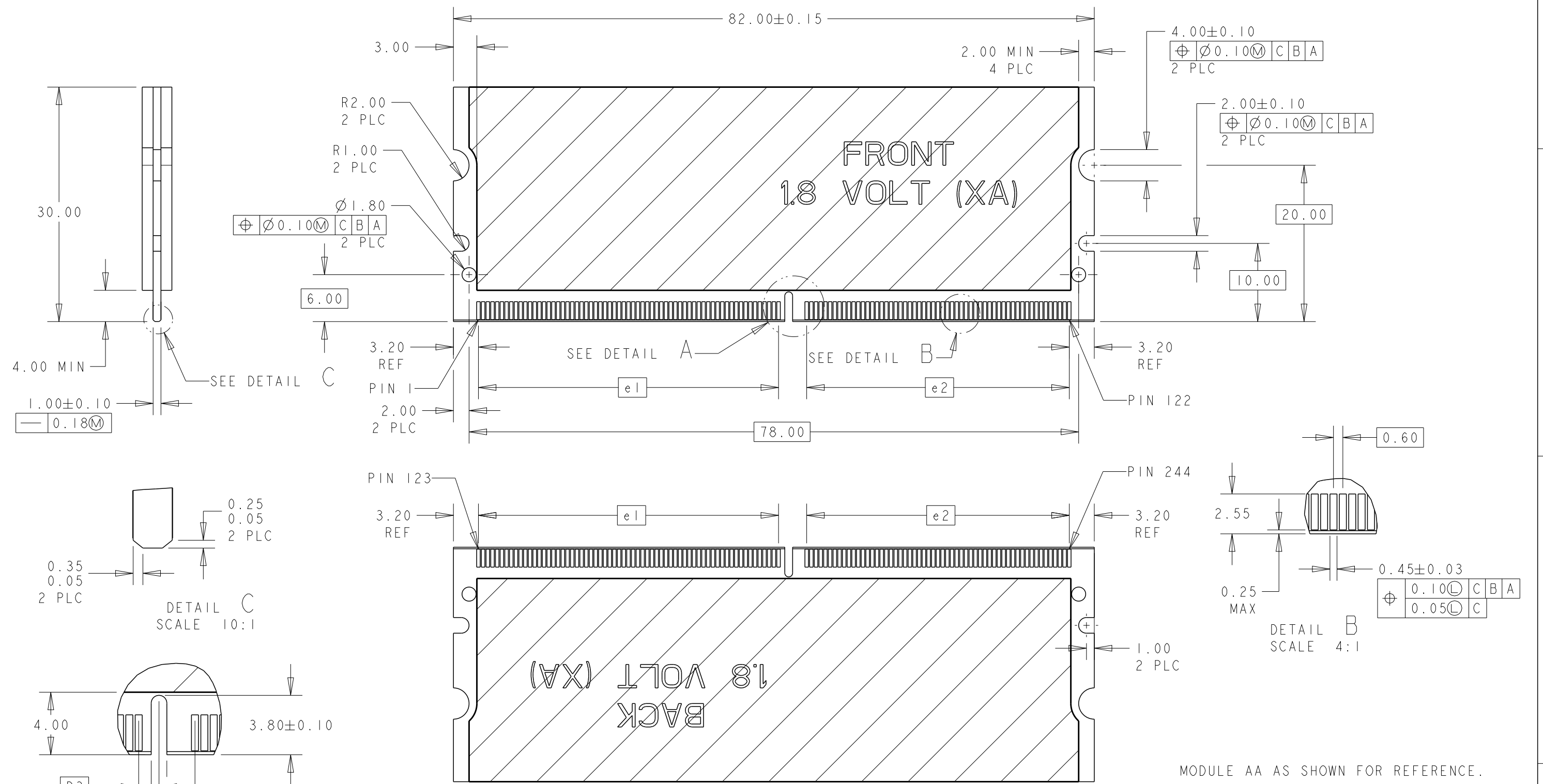


P/N X- -4
(1.5V STD)
SCALE 3:2

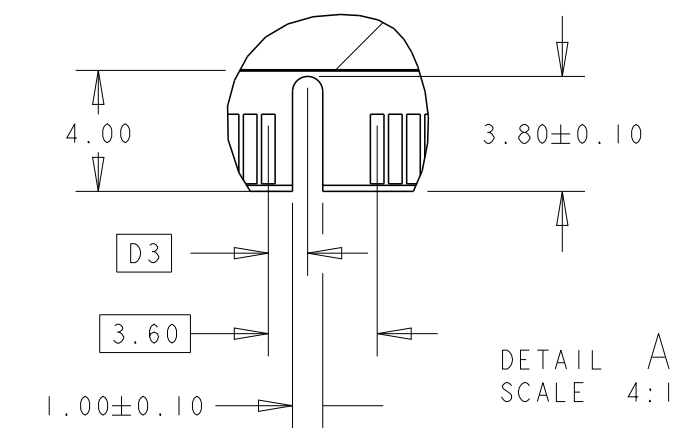
THIS DRAWING IS A CONTROLLED DOCUMENT FOR AMP INCORPORATED. IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.		DWN WYLEE 18MAY2007	STE TE CONNECTIVITY Singapore
DIMENSIONS: mm		CHK YJ SEE	
TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± 1 PLC ±0.25 2 PLC ±0.13 3 PLC ±0.10 4 PLC ± ANGLES ±1°		APVD SF LEONG	NAME ASSEMBLY, MINIDIMM, R/A, LF 0.60mm PITCH, 244 CKTS, DDR2/3
MATERIAL		PRODUCT SPEC 108-51091	
FINISH SEE P/N TABLE		APPLICATION SPEC 114-51011	SIZE A3
		WEIGHT -	CAGE CODE 00779
		CUSTOMER DRAWING	DRAWING NO C-1735438
			SCALE 3:2 SHEET 2 OF 5 REV B5

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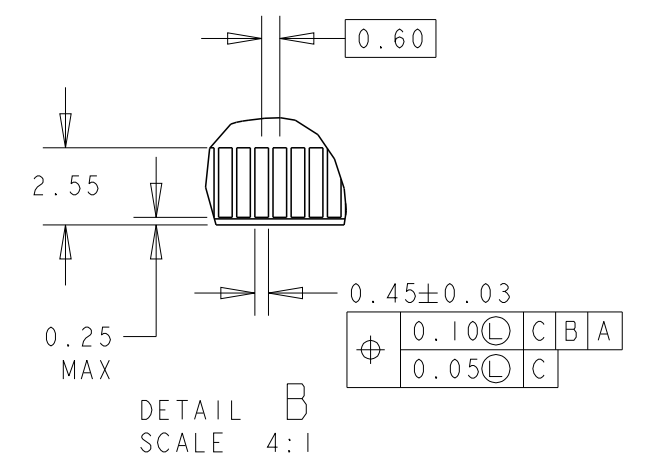
LOC DY	DIST -	REVISIONS		
P	LTR	DESCRIPTION	DATE	DWN
-	-	SEE SHEET 1	-	-



MODULE AA AS SHOWN FOR REFERENCE.



DETAIL A
SCALE 4:1



DETAIL B
SCALE 4:1

DETAIL C
SCALE 10:1

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DIMENSIONS: mm	TOLERANCES UNLESS OTHERWISE SPECIFIED:
0 PLC	±
1 PLC	±0.25
2 PLC	±0.13
3 PLC	±0.10
4 PLC	±
ANGLES	±1°
MATERIAL	FINISH

DWN WYLEE	18MAY2007
CHK YJ SEE	
APVD SF LEONG	
PRODUCT SPEC	108-51091
APPLICATION SPEC	114-51011
WEIGHT	-

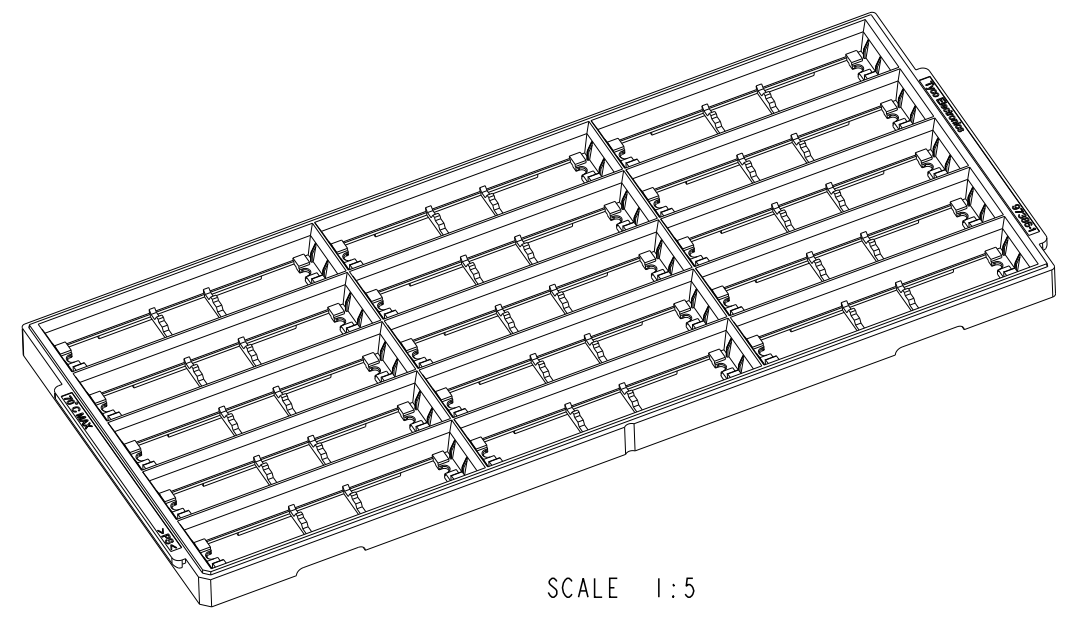
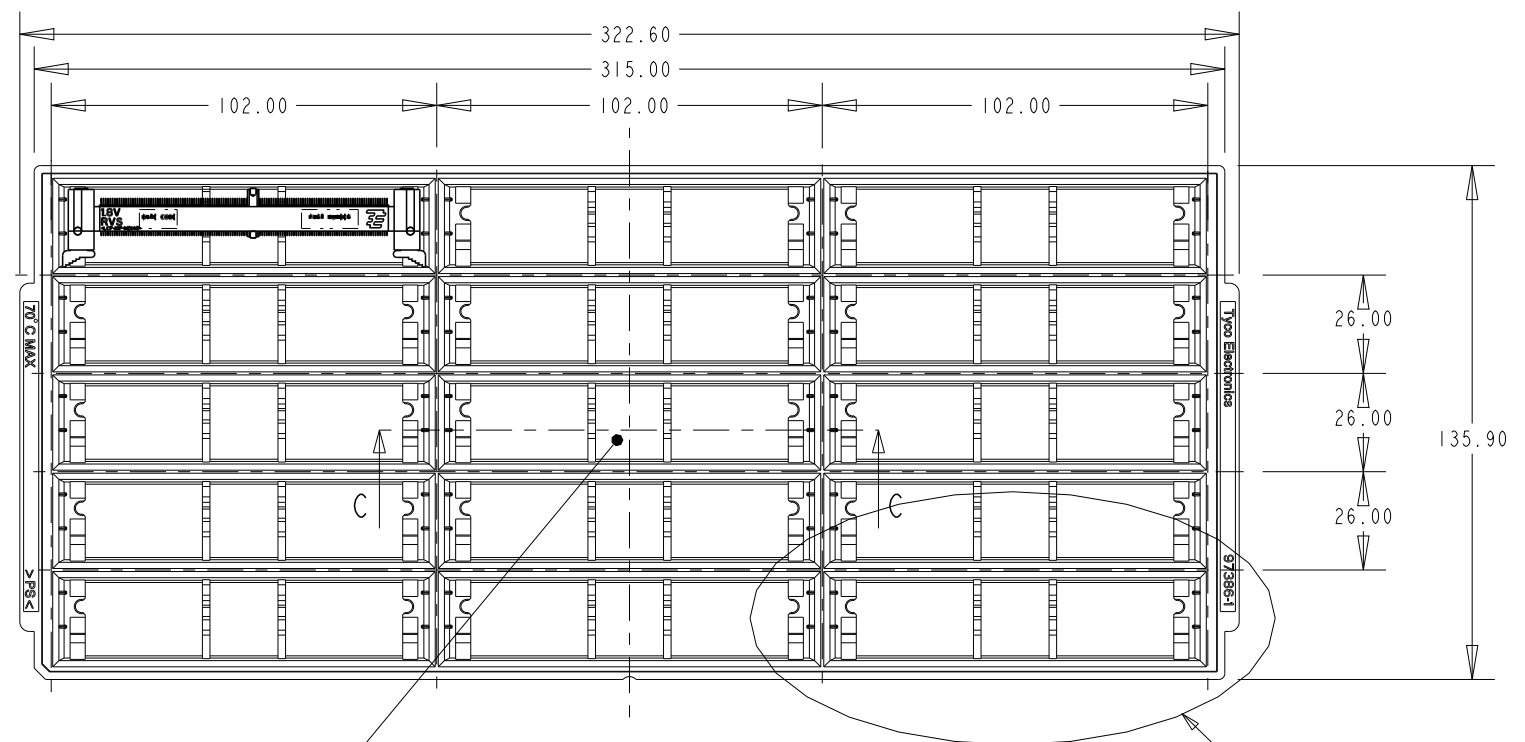
STE TE CONNECTIVITY Singapore	
NAME ASSEMBLY, MINIDIMM, R/A, LF 0.60mm PITCH, 244 CKTS, DDR2/3	
SIZE A3	CAGE CODE 00779
DRAWING NO C=1735438	

FOR P/N X- -2 AND X- -4.	2.3	33.6	38.4	1.5V	AB/BB/CB
FOR P/N X- -1 AND X- -3.	1.3	33.6	38.4	1.8V	AA/BA/CA
REMARKS	D3	e2	e1	VOLTAGE MARKING	MODULE VARIATION

CUSTOMER DRAWING	SCALE 1:1	SHEET 4 OF 5	REV B5
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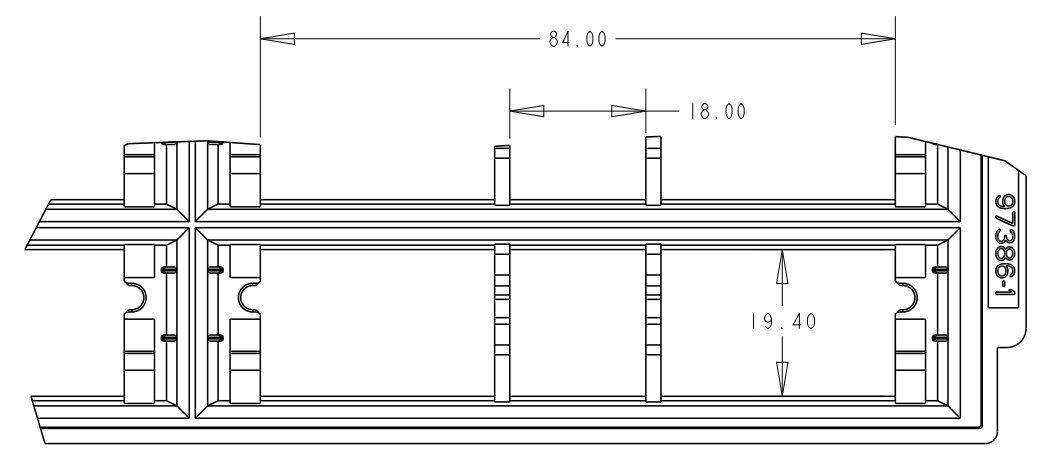
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LOC	DIST	REVISIONS				
P	LTR	DESCRIPTION	DATE	DWN	APVD	
DY	-	SEE SHEET 1	-	-	-	



Base of centre pocket is solid.

SEE DETAIL A



SECTION C-C

DETAIL A
SCALE 2:1

<small>THIS DRAWING IS A CONTROLLED DOCUMENT FOR AMP INCORPORATED. IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.</small>		DWN WYLEE 18MAY2007 CHK YJ SEE APVD SF LEONG PRODUCT SPEC 108-51091 APPLICATION SPEC 114-51011 WEIGHT -	STE TE CONNECTIVITY Singapore NAME ASSEMBLY, MINIDIMM, R/A, LF 0.60mm PITCH, 244 CKTS, DDR2/3
DIMENSIONS: mm 	TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± 1 PLC ±0.25 2 PLC ±0.13 3 PLC ±0.10 4 PLC ± ANGLES ±1°	SIZE A3 CAGE CODE 00779 DRAWING NO ©-1735438	SCALE 1:1 SHEET 5 OF 5 REV B5
MATERIAL	FINISH	CUSTOMER DRAWING	

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

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